- Ultra-Fast Operation . . . 10 ns (typ)
- Low Positive Supply Current 12.7 mA (Typ)
- Operates From a Single 5-V Supply or From a Split ±5-V Supply
- Complementary Outputs
- Input Common-Mode Voltage Includes Negative Rail
- Low Offset Voltage
- No Minimum Slew Rate Requirement
- Output Latch Capability
- Functional Replacement to the LT1116

## description

The TL3116 is an ultra-fast comparator designed to interface directly to TTL logic while operating from either a single 5-V power supply or dual ±5-V supplies. The input common-mode voltage extends to the negative rail for ground sensing applications. It features extremely tight offset voltage and high gain for precision applications. It has complementary outputs that can be latched using the LATCH ENABLE terminal. Figure 1 shows the positive supply current of the comparator. The TL3116 only requires 12.7 mA (typical) to achieve a propagation delay of 10 ns.

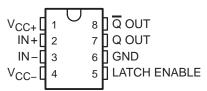
The TL3116 is a pin-for-pin functional replacement for the LT1116 comparator, offering high-speed operation but consuming much less power.

#### **AVAILABLE OPTIONS**

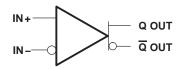
	PACKAGED	0.115			
TA	SMALL OUTLINE† (D)	TSSOP (PW)	CHIP FORM <sup>‡</sup> (Y)		
0°C to 70°C	TL3116CD	TL3116CPWLE	TL3116Y		
-40°C to 85°C	TL3116ID	TL3116IPWLE	_		

<sup>†</sup>The PW packages are available left-ended taped and reeled only.

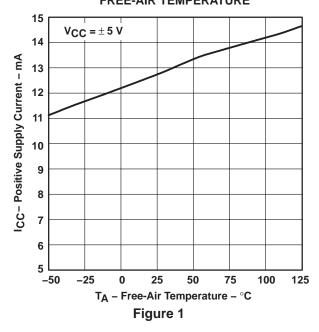
#### D AND PW PACKAGE (TOP VIEW)



#### symbol (each comparator)



# POSITIVE SUPPLY CURRENT vs FREE-AIR TEMPERATURE





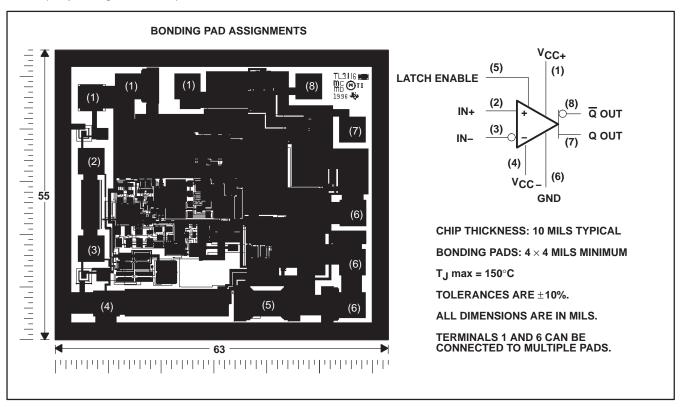
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



<sup>‡</sup> Chip forms are tested at  $T_A = 25$ °C only.

#### **TL3116Y chip information**

This chip, when properly assembled, displays characteristics similar to the TL3116C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. Chips may be mounted with conductive epoxy or a gold-silicon preform.



COMPONENT COUNT						
Bipolars	53					
MOSFETs	49					
Resistors	46					
Capacitors	14					



# TL3116, TL3116Y ULTRA-FAST LOW-POWER PRECISION COMPARATORS

SLCS132C - MARCH 1997 - REVISED MAY 1997

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>DD</sub> (see Note 1)	– 7 V to 7 V
Differential input voltage, V <sub>ID</sub> (see Note 2)	
Input voltage range, V <sub>I</sub>	
Input voltage, V <sub>I</sub> (LATCH ENABLE)	7 V
Output current, I <sub>O</sub>	±20 mA
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T <sub>A</sub>	40°C to 85°C
Storage temperature range, T <sub>stq</sub>	– 65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

NOTES: 1. All voltage values, except differential voltages, are with respect to network ground.

2. Differential voltages are at IN+ with respect to IN-.

#### **DISSIPATION RATING TABLE**

PACKAGE	T <sub>A</sub> ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING		
D	725 mW	5.8 mW/°C	464 mW		
PW	525 mW	4.2 mW/°C	336 mW		



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# TL3116, TL3116Y ULTRA-FAST LOW-POWER PRECISION COMPARATORS

SLCS132C - MARCH 1997 - REVISED MAY 1997

## electrical characteristics at specified operating free-air temperature, $V_{DD}$ = $\pm 5$ V, $V_{LE}$ = 0 (unless otherwise noted)

242445752	TEGT COMPLETIONS.		TL3116C		TL3116I			LINUT
PARAMETER	M		TYP‡	MAX	MIN	TYP‡	MAX	UNIT
lanut effect veltere	T <sub>A</sub> = 25°C		0.5	3		0.5	3	\/
input offset voltage	T <sub>A</sub> = full range			3.5			3.5	mV
Temperature coefficient of input offset voltage			-2.5			-2.8		μV/°C
	T <sub>A</sub> = 25°C		0.1	0.2		0.1	0.2	
Input offset current	T <sub>A</sub> = full range			0.3			0.35	μΑ
	T <sub>A</sub> = 25°C		0.7	1.1		0.7	1.1	
Input bias current	T <sub>A</sub> = full range			1.2			1.5	μΑ
Common-mode input	V <sub>DD</sub> = ±5 V	-5		2.5	-5		2.5	
voltage range	V <sub>DD</sub> = 5 V	0		2.5	0		2.5	V
Common-mode rejection ratio	-5 ≤ V <sub>IC</sub> ≤ 2.5 V	75	100		75	100		dB
Supply-voltage rejection	Positive supply: $4.6 \text{ V} \le +\text{V}_{DD} \le 5.4 \text{ V}$ , $T_A = 25^{\circ}\text{C}$	60	80		60	80		
ratio	Negative supply: $-7 \text{ V} \le -\text{V}_{DD} \le -2 \text{ V}$ , $T_A = 25^{\circ}\text{C}$	80	100		80	100		dB
Landard advisor	$I_{(sink)} = 4 \text{ mA}, V+ \leq 4.6 \text{ V},$ $T_A = 25^{\circ}\text{C}$		400	600		400	600	
Low-level output voltage	$I_{(sink)}$ = 10 mA, V+ $\leq$ 4.6 V, $T_A$ = 25°C		750			750		mV
I Park I south out out on the con-	$V+ \leq 4.6 \text{ V}, \\ T_A = 25^{\circ}\text{C}$ $I_O = 1 \text{ mA},$	3.6	3.9		3.6	3.9		.,
High-level output voltage	$V+ \leq 4.6 \ V, \\ T_{\mbox{\scriptsize A}} = 25 \mbox{\rm °C} \label{eq:total one of the constraint}$	3.4	3.8		3.4	3.8		V
Positive supply current	T. Gilliana and		12.7	14.7		12.7	15	4
Negative supply current	I <sub>A</sub> = full range	-2.6			-3			mA
Low-level input voltage (LATCH ENABLE)				0.8			0.8	٧
High-level input voltage (LATCH ENABLE)		2			2			V
Low-level input current	V <sub>LE</sub> = 0		0	1		0	1	μΑ
(LATCH ENABLE)	V <sub>LE</sub> = 2 V		24	39		24	45	μΑ
	of input offset voltage  Input offset current  Input bias current  Common-mode input voltage range  Common-mode rejection ratio  Supply-voltage rejection ratio  Low-level output voltage  Positive supply current  Negative supply current  Low-level input voltage (LATCH ENABLE)  High-level input current	$ \begin{array}{c} \text{Input offset voltage} & \begin{array}{c} T_{A} = 25^{\circ}\text{C} \\ \hline T_{A} = \text{full range} \end{array} \\ \hline \text{Temperature coefficient of input offset voltage} \\ \hline \text{Input offset current} & \begin{array}{c} T_{A} = 25^{\circ}\text{C} \\ \hline T_{A} = \text{full range} \end{array} \\ \hline \text{Input offset current} & \begin{array}{c} T_{A} = 25^{\circ}\text{C} \\ \hline T_{A} = \text{full range} \end{array} \\ \hline \text{Input bias current} & \begin{array}{c} T_{A} = 25^{\circ}\text{C} \\ \hline T_{A} = \text{full range} \end{array} \\ \hline \text{Common-mode input voltage range} & \begin{array}{c} V_{DD} = \pm 5 \text{ V} \\ V_{DD} = 5 \text{ V} \end{array} \\ \hline \text{Common-mode rejection ratio} & \begin{array}{c} -5 \leq \text{V}_{ C} \leq 2.5 \text{ V} \end{array} \\ \hline \text{Supply-voltage rejection ratio} & \begin{array}{c} P_{\text{Ositive supply: } 4.6 \text{ V} \leq +\text{V}_{DD} \leq 5.4 \text{ V},} \\ T_{A} = 25^{\circ}\text{C} \\ \hline \text{Negative supply: } -7 \text{ V} \leq -\text{V}_{DD} \leq -2 \text{ V},} \\ T_{A} = 25^{\circ}\text{C} \\ \hline \text{I(sink) = 10 mA,} & \text{V+} \leq 4.6 \text{ V},} \\ T_{A} = 25^{\circ}\text{C} \\ \hline \text{I(sink) = 10 mA,} & \text{V+} \leq 4.6 \text{ V},} \\ T_{A} = 25^{\circ}\text{C} \\ \hline \end{array} \\ \hline \text{Positive supply current} \\ \hline \text{Negative supply current} \\ \hline \text{Negative supply current} \\ \hline \text{Low-level input voltage} \\ \hline \text{I(ATCH ENABLE)} \\ \hline \text{Low-level input current} \\ \hline \text{Low-level input current} \\ \hline \text{Low-level input current} \\ \hline \end{array} \\ \hline \text{VLE = 0} \\ \hline \end{array}$	$ \begin{array}{c} \text{Input offset voltage} \\ \text{Ta} = 25^{\circ}\text{C} \\ \hline T_{A} = \text{full range} \\ \\ \text{Input offset current} \\ \\ \text{Input offset current} \\ \\ \text{Input offset current} \\ \\ \text{Input bias current} \\ \\ Input$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$

<sup>†</sup> Full range for the TL3116C is  $T_A = 0^{\circ}$ C to  $70^{\circ}$ C. Full range for the TL3116I is  $T_A = -40^{\circ}$ C to  $85^{\circ}$ C. ‡ All typical values are measures with  $T_A = 25^{\circ}$ C.



## switching characteristics, $V_{DD} = \pm 5 \text{ V}$ , $V_{LE} = 0$

DADAMETED		7507.001	TL3116C			TL3116I				
	PARAMETER	TEST CON	MIN TYP MAX MIN TYP		MAX	UNIT				
t <sub>pd1</sub> Propagation delay time‡	$\Delta V_{\parallel} = 100 \text{ mV},$	T <sub>A</sub> = 25°C		9.9	12		9.9	12		
	$V_{OD} = 5 \text{ mV}$	T <sub>A</sub> = full range		9.9	14		9.9	15		
	Propagation delay time+	$\Delta V_I = 100 \text{ mV},$ $V_{OD} = 20 \text{ mV}$	T <sub>A</sub> = 25°C		8.2	10.3		8.2	10.3	ns
			T <sub>A</sub> = full range		8.2	12.7		8.2	13.7	
t <sub>sk(p)</sub>	Pulse skew ( $ t_{pd+} - t_{pd-} $ )	$\Delta V_I = 100 \text{ mV},$ $T_A = 25^{\circ}\text{C}$	$V_{OD} = 5 \text{ mV},$		0.5			0.5		ns
t <sub>su</sub>	Setup time, LATCH ENABLE				3.4			3.4		ns

<sup>&</sup>lt;sup>†</sup> Full range for the TL3116C is 0°C to 70°C. Full range for the TL3116I is –40°C to 85°C.

#### **TYPICAL CHARACTERISTICS**

#### **Table of Graphs**

			FIGURE
		vs Input voltage	2
ICC	Positive supply current	vs Frequency	3
		vs Free-air temperature	4
ICC	Negative supply current	vs Free-air temperature	5
		vs Overdrive voltage	6
	Propagation delay time	vs Supply voltage	7
t <sub>pd</sub>		vs Input impedance	8
ļ ·		vs Load capacitance	9
		vs Free-air temperature	10
VIС	Common-mode input voltage	vs Free-air temperature	11
$\vee_{IT}$	Input threshold voltage (LATCH ENABLE)	vs Free-air temperature	12
,,	0	vs Output source current	13
Vo	Output voltage	vs Output sink current	14
lį	Input current (LATCH ENABLE)	vs Input voltage	15

<sup>‡</sup> t<sub>pd1</sub> cannot be measured in automatic handling equipment with low values of overdrive. The TL3116 is 100% tested with a 1-V step and 500-mV overdrive at T<sub>A</sub> = 25°C only. Correlation tests have shown that t<sub>pd1</sub> limits given can be ensured with this test, if additional dc tests are performed to ensure that all internal bias conditions are correct. For low overdrive conditions, V<sub>OS</sub> is added to the overdrive.

20

18

16

14

12

10

8

2

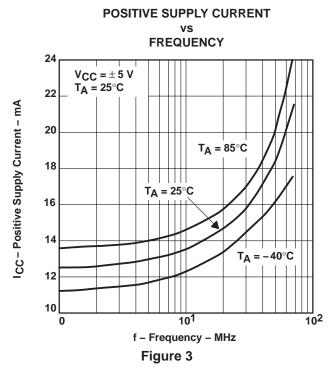
0

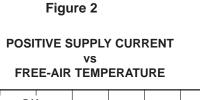
ICC - Positive Supply Current - mA

#### TYPICAL CHARACTERISTICS

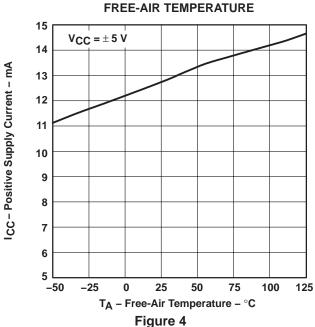
8

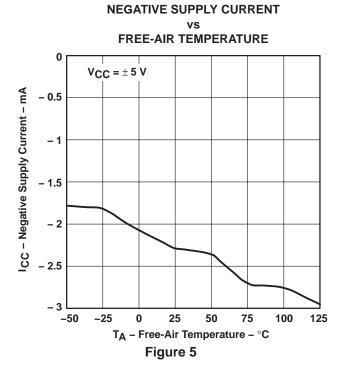
# **POSITIVE SUPPLY CURRENT INPUT VOLTAGE** $V_{CC} = \pm 5 V$ T<sub>A</sub> = 25°C T<sub>A</sub> = 85°C T<sub>A</sub> = 25°C $T_A = -40^{\circ}C$





V<sub>I</sub> - Input Voltage - V





#### **TYPICAL CHARACTERISTICS**

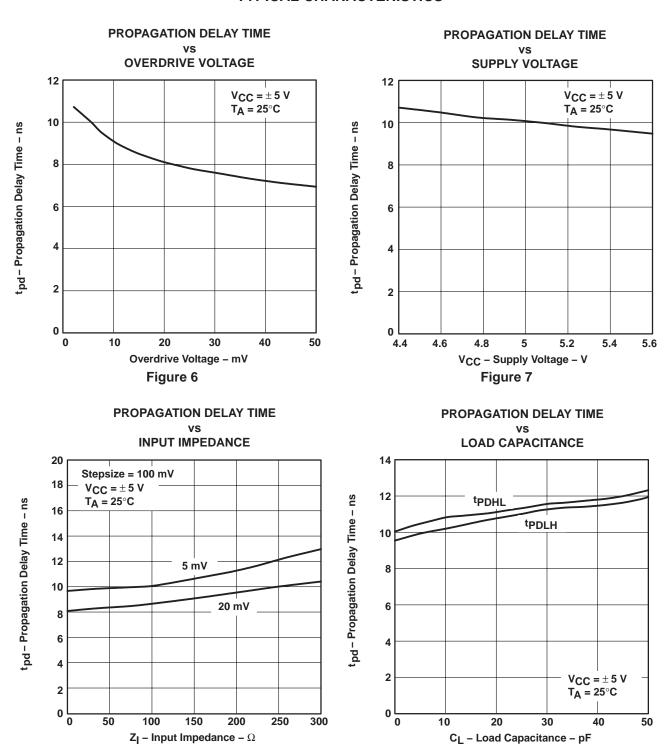


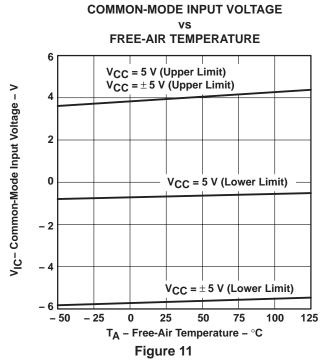


Figure 9

Figure 8

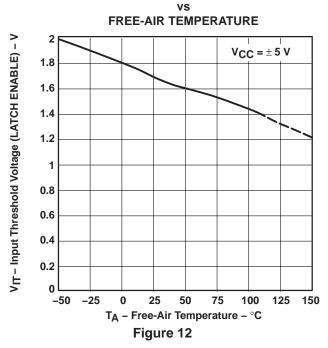
#### TYPICAL CHARACTERISTICS

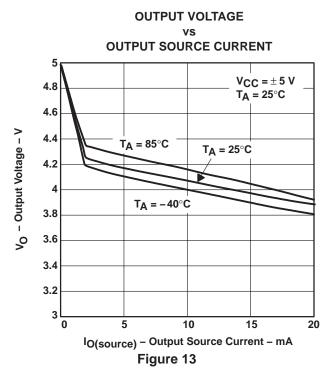
# **PROPAGATION DELAY TIME** FREE-AIR TEMPERATURE 25 $V_{CC} = \pm 5 V$ tpd - Propagation Delay Time - ns 20 15 Rising Edge 10 **Falling Edge** 5 75 100 125 - 50 - 25 50 T<sub>A</sub> - Free-Air Temperature - °C



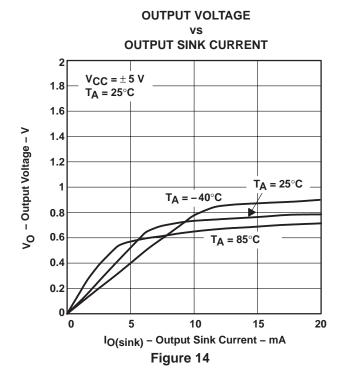
# INPUT THRESHOLD VOLTAGE (LATCH ENABLE)

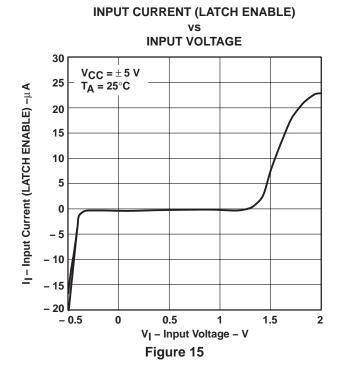
Figure 10





#### **TYPICAL CHARACTERISTICS**





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11-Nov-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow (5)		(6)
TL3116CD	Obsolete	Production	SOIC (D)   8	-	-	Call TI	Call TI	0 to 70	3116C
TL3116CDR	Obsolete	Production	SOIC (D)   8	-	-	Call TI	Call TI	0 to 70	3116C
TL3116CPWR	Obsolete	Production	TSSOP (PW)   8	-	-	Call TI	Call TI	0 to 70	T3116
TL3116ID	Obsolete	Production	SOIC (D)   8	-	-	Call TI	Call TI	-40 to 85	3116I
TL3116IDR	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	3116l
TL3116IDR.A	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	3116l
TL3116IPWR	Active	Production	TSSOP (PW)   8	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Z3116
TL3116IPWR.A	Active	Production	TSSOP (PW)   8	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Z3116

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE OPTION ADDENDUM**

www.ti.com 11-Nov-2025

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 24-Jul-2025

#### TAPE AND REEL INFORMATION



# TAPE DIMENSIONS KO P1 BO W Cavity A0

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL3116IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL3116IPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1

**PACKAGE MATERIALS INFORMATION** 

www.ti.com 24-Jul-2025



#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Drawing Pins SPQ Length (mm) Width (n		Width (mm)	Height (mm)	
TL3116IDR	SOIC	D	8	2500	350.0	350.0	43.0
TL3116IPWR	TSSOP	PW	8	2000	353.0	353.0	32.0



SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.





SMALL OUTLINE PACKAGE



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153, variation AA.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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